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APPLICATION NUMBER

FILING/RECEIPT DATE

FIRST NAMED APPLICANT

ATTORNEY DOCKET NUMBER

09/761,886

01/17/2001

Ashok Krishnamoorthy

Aralight-1

Keith Goossen 137 Easy Street Howell, NJ 07731 CONFIRMATION NO. 6027 FORMALITIES LETTER 「加加」「開始」「開始」「開始」「開始」「 *OC00000005923785*

Date Mailed: 04/02/2001

NOTICE TO FILE CORRECTED APPLICATION PAPERS

Filing Date Granted

This application has been accorded an Application Number and Filing Date. The application, however, is informal since it does not comply with the regulations for the reason(s) Indicated below. Applicant is given TWO MONTHS from the date of this Notice within which to correct the informalities indicated below. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a)

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
 - drawing sheets do not have the appropriate margin(s) (see 37 CFR 1.84(g)). Each sheet must include a top margin of at least 2.5 cm. (1 inch), a left side margin of at least 2.5 cm. (1 lnch), a right side margin of at least 1.5 cm. (5/8 inch), and a bottom margin of at least 1.0 cm. (3/8 inch);

A copy of this notice MUST be returned with the reply.

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

JUN 0 6 2001 👺

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Group Art Unit: ---

Examiner: ---

Applicant: Krishnamoorthy et al.

Serial No.: 09/761,886

Filing Date: 01/17/2001

For: Bonding Pad for Flip-Chip

Fabrication

LETTER

Commissioner of Patents and Trademarks Washington, DC 20231

Sir:

In this application, Applicants received a Notice to File Corrected Application Papers, mailed on April 2, 2001, copy enclosed. The Notice asserted that Applicants' drawings, as filed, lacked proper margins.

The undersigned attorney mailed corrected drawings on May 11, 2001. However, by mistake, Figure 11 was omitted.

A complete set of corrected drawings is herewith submitted. This complete set is being mailed within the two-month time period allowed by the Notice.

Formal drawings, on Bristol, are also enclosed.

Respectfully submitted,

Gregory A. Welte Reg. No. 30,434

806N County Road 700W Frankfort, IN 46041 June 1, 2001

(765) 296 - 4699

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE TO 26 JO MAIL ROOM

& TRANKE torney Docket No.: Aralight-1

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Bonding Pad for Flip-Chip For:

Fabrication

CERTIFICATE OF MAILING

I certify that the documents contained herewith, namely, six sheets of drawings, each bearing the following legend

Bonding Pad for Flip-Chip Fabrication - Goossen & Krishnamoorthy Atty - G Welte (765) 296 - 4699 S/N 09/761,886

are addressed to the Commissioner of Patents and Trademarks, Washington, D.C., 20231, and will be deposited with the U.S. Postal Service, first class postage prepaid, on June 1, 2001.